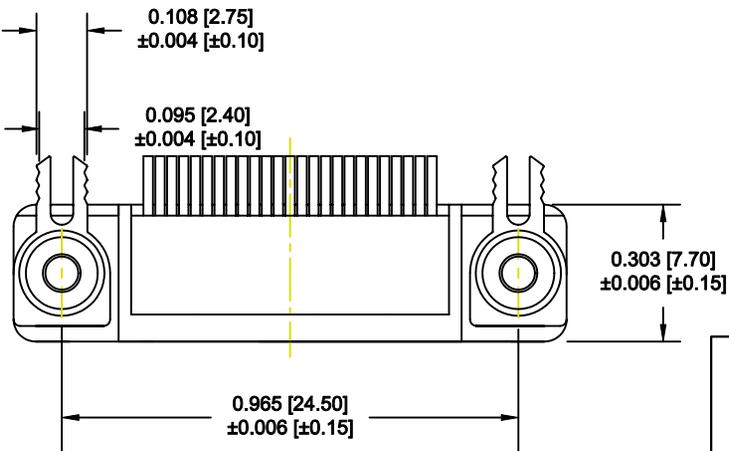
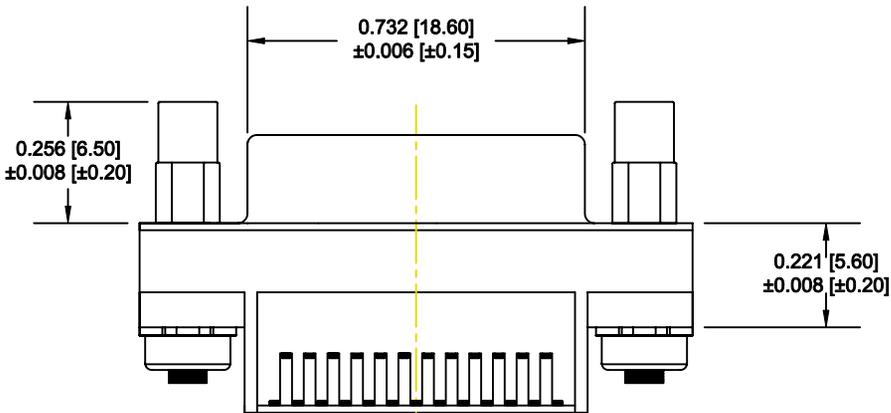
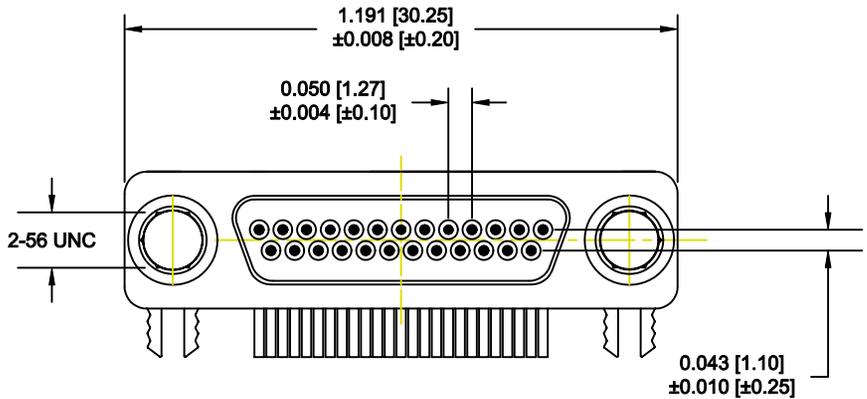


DESCRIPTION: MICRO D-SUB CONNECTOR - MALE - RIGHT ANGLE



**ELECTRICAL**

CONTACT CURRENT RATING: 1 AMP  
 DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC  
 INSULATION RESISTANCE: 1000 MOhms MIN.  
 CONTACT RESISTANCE: 45 MILLI Ohms MAX.  
 OPERATING TEMPERATURE: -55°C TO +85°C

**MATERIALS**

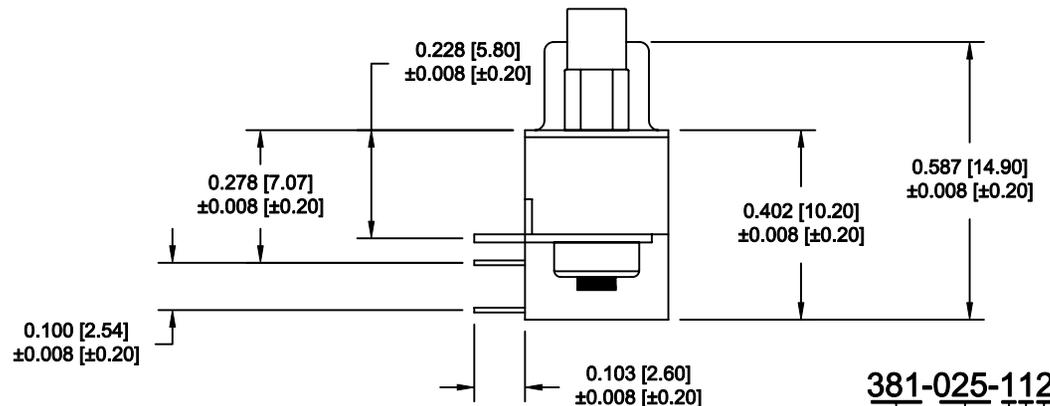
CONTACTS: COPPER ALLOY  
 INSULATOR: THERMOPLASTIC 94V-0  
 SHELL: COLD ROLLER STEEL

**FINISHES**

CONTACT: 15 μ" MIN. GOLD ON MATING END  
 TIN ON TERMINATION END  
 ALL UNDERPLATING NICKEL  
 SHELL: BRIGHT TIN OVER COPPER

**HARDWARE**

2-56 THREADED STANDOFF  
 2.5 IN-LBS TORQUE MAX.



**381-025-112L5Y5**

SERIES \_\_\_\_\_  
 POSITIONS \_\_\_\_\_  
 GENDER \_\_\_\_\_  
 1 = MALE  
 TERMINATION \_\_\_\_\_  
 1 = DIP SOLDER  
 SHELL PLATING \_\_\_\_\_  
 2 = TIN  
 RoHS COMPLIANT \_\_\_\_\_  
 HARDWARE OPTIONS \_\_\_\_\_  
 1 = BOARDLOCKS ONLY  
 6 = STANDOFFS & BOARDLOCKS  
 PLATING OPTIONS \_\_\_\_\_  
 5 = 15u" GOLD PLATING

DO NOT SCALE FROM DRAWING

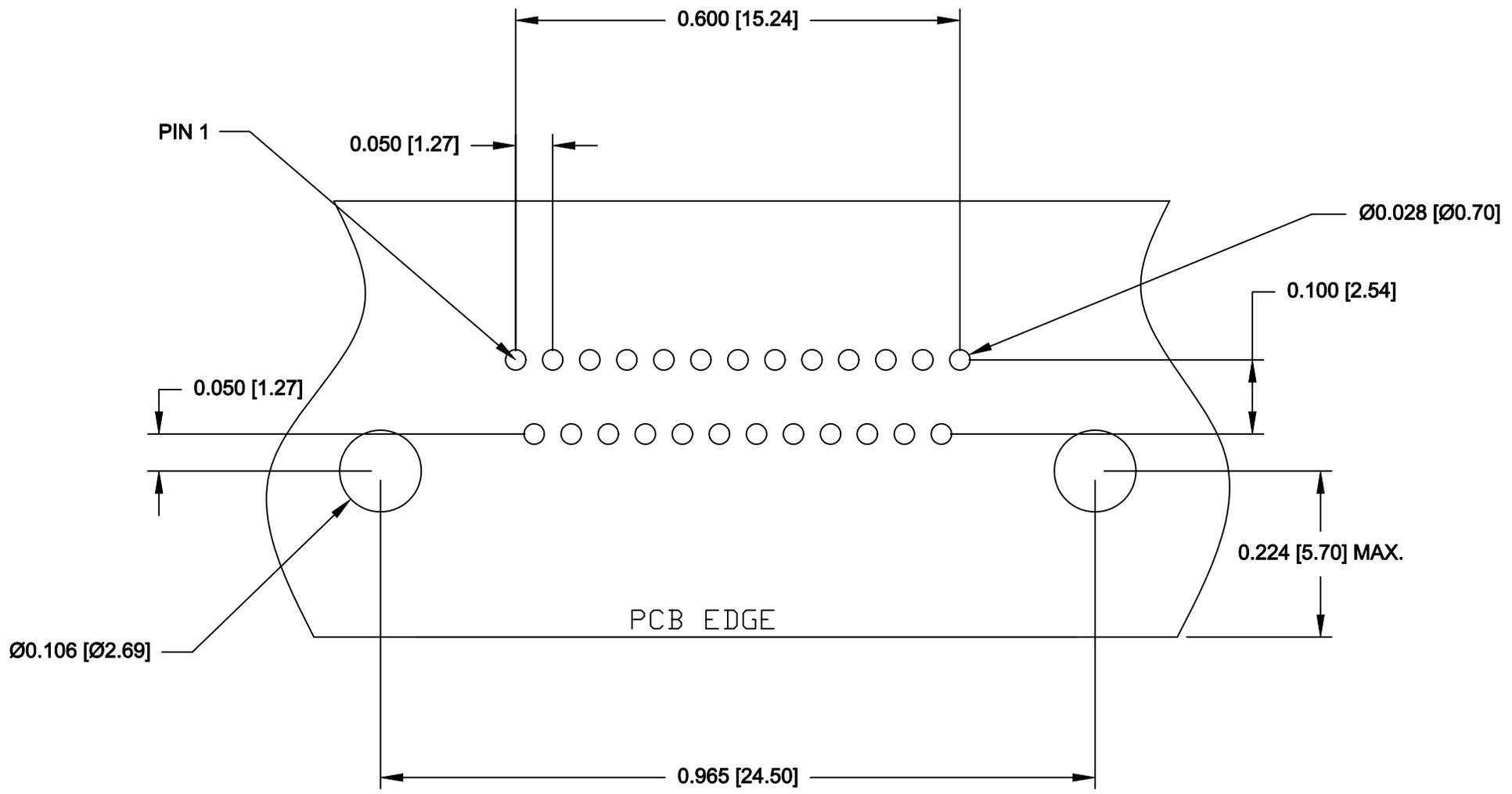


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DRAWN: M. SIGMON		DATE: 08-22-11	
CHECKED:		DATE:	
SCALE: 2.5 : 1	SHEET 1	OF 2	REV 2
DWG NO. 381-025-112L565			

RoHS COMPLIANT

**NorComp**



RECOMMENDED PC BOARD LAYOUT  
(25 POSITION ONLY) TOLERANCE ±0.002 [±0.05]

DO NOT SCALE FROM DRAWING

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			CHECKED:	DATE:
<h1>NorComp</h1>		SCALE: <b>5 : 1</b>	SHEET <b>2</b>	OF <b>2</b>
		DWG NO. <b>381-025-112L565</b>		

RoHS COMPLIANT